Vishay Siliconix

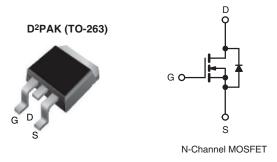
COMPLIANT

HALOGEN

FREE

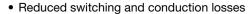
E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.145		
Q _g (Max.) (nC)	86			
Q _{gs} (nC)	14			
Q _{gd} (nC)	25			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (Ciss)



- Low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATONS

- Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB25N50E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	500		
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	26	A	
	V _{GS} at 10 V	T _C = 100 °C		16		
Pulsed Drain Current ^a			I _{DM}	50		
Linear Derating Factor				0.2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	273	mJ	
Maximum Power Dissipation			P_{D}	250	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 V t$	V _{DS} = 0 V to 80 % V _{DS} dV/dt		65	V/ns	
Reverse Diode dV/dt ^d		uv/at	25	V/IIS		
Soldering Recommendations (Peak Temperature	e) ^c for	for 10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.4 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	=	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/VV	



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4.0	V
Cata Caura I adraga		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zero Gate Voltage Drain Current	l	V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	1	μА
Zero Gate Voltage Drain Gurrent	I _{DSS}	V _{DS} = 400 \			-	25	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.125	0.145	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 12 A		-	6.6	-	S
Dynamic							
Input Capacitance	C_{iss}	V _{GS} = 0 V,		-	1980	-	pF
Output Capacitance	C_{oss}		$V_{DS} = 100 \text{ V},$		105	-	
Reverse Transfer Capacitance	C_{rss}	f = 1 MHz		-	8	-	
Effective Output Capacitance, Energy Related ^a	$C_{o(er)}$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	105	-	
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	285	-	
Total Gate Charge	Qg			-	57	86	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 400 \text{ V}$		14	-	nC
Gate-Drain Charge	Q _{gd}			-	25	-	1
Turn-On Delay Time	t _{d(on)}			-	19	38	
Rise Time	t _r	V _{DD} =	V _{DD} = 400 V, I _D = 12 A		36	72	ns
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$, $V_{GS} = 10 V$		-	57	86	
Fall Time	t _f				29	58	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.56	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET syml showing the	MOSFET symbol showing the		-	12	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	50	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C, I}_F = I_S,$ $dI/dt = 100 \text{ A/}\mu\text{s, V}_R = 25 \text{ V}$		-	338	-	ns
Reverse Recovery Charge	Q_{rr}			-	5.3	-	μC
Reverse Recovery Current	I _{RRM}			-	29	-	Α

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

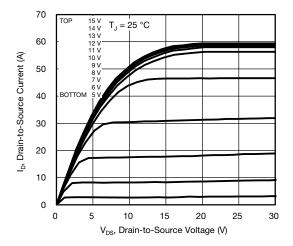


Fig. 1 - Typical Output Characteristics

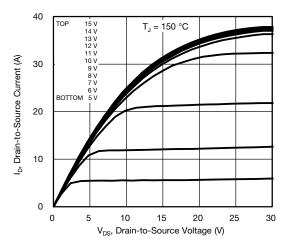


Fig. 2 - Typical Output Characteristics

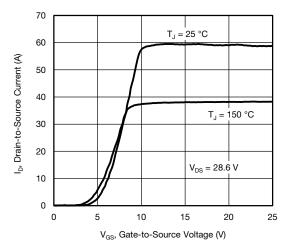


Fig. 3 - Typical Transfer Characteristics

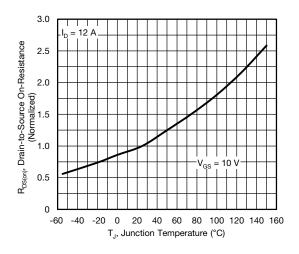


Fig. 4 - Normalized On-Resistance vs. Temperature

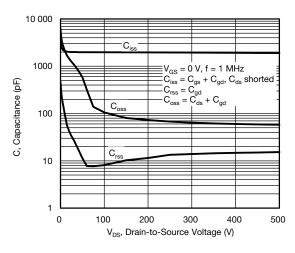


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

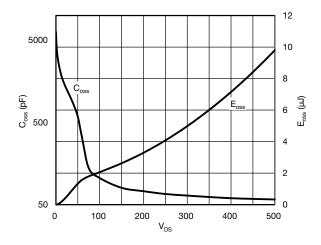


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}



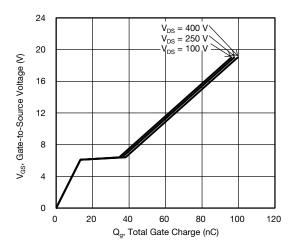


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

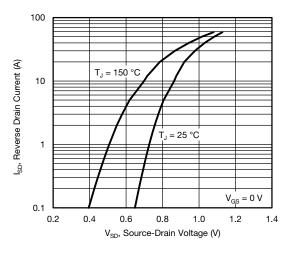


Fig. 8 - Typical Source-Drain Diode Forward Voltage

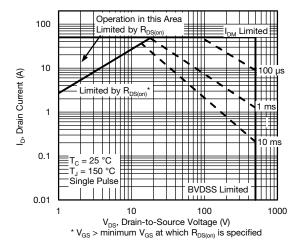


Fig. 9 - Maximum Safe Operating Area

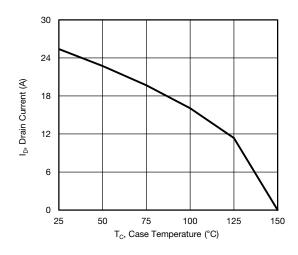


Fig. 10 - Maximum Drain Current vs. Case Temperature

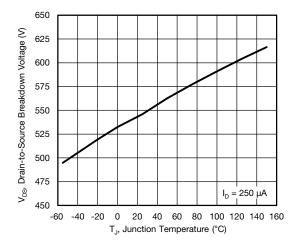


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



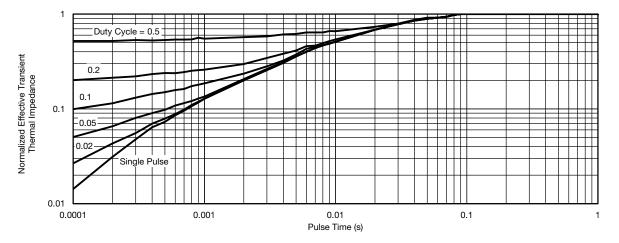


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

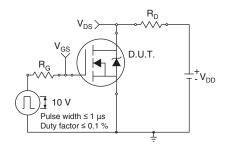


Fig. 13 - Switching Time Test Circuit

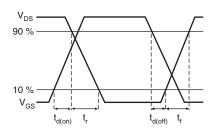


Fig. 14 - Switching Time Waveforms

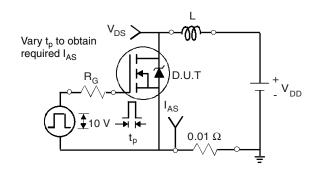


Fig. 15 - Unclamped Inductive Test Circuit

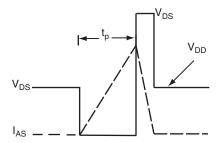


Fig. 16 - Unclamped Inductive Waveforms

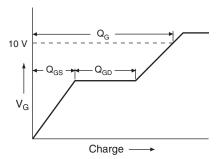


Fig. 17 - Basic Gate Charge Waveform

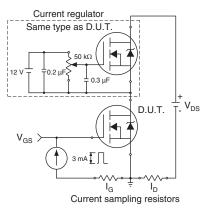
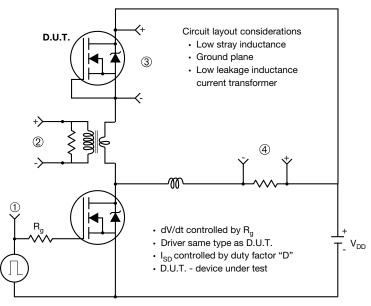


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



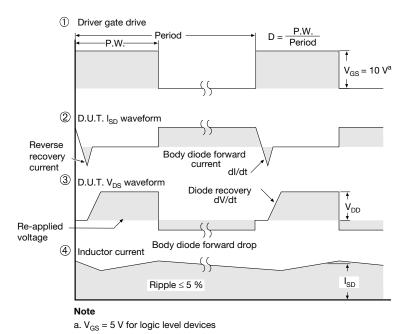


Fig. 19 - For N-Channel

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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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